



US00D933585S

(12) **United States Design Patent** (10) **Patent No.:** **US D933,585 S**
Morad et al. (45) **Date of Patent:** **** Oct. 19, 2021**

(54) **SOLAR PANEL**

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Japanese Office Action dated Apr. 7, 2020, in Patent Application No. 2019-790, 6 pages (with unedited computer generated English translation).

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(57) **CLAIM**

(**) Term: **15 Years**

The ornamental design for a solar panel, as shown and described.

(21) Appl. No.: **29/691,290**

DESCRIPTION

(22) Filed: **May 15, 2019**

Related U.S. Application Data

(60) Division of application No. 29/617,566, filed on Sep. 14, 2017, which is a continuation of application No. (Continued)

(51) **LOC (13) Cl.** **13-02**

(52) **U.S. Cl.**
USPC **D13/102**

(58) **Field of Classification Search**
USPC D13/102, 101, 103, 110, 118, 133, 182, D13/184, 199

(Continued)

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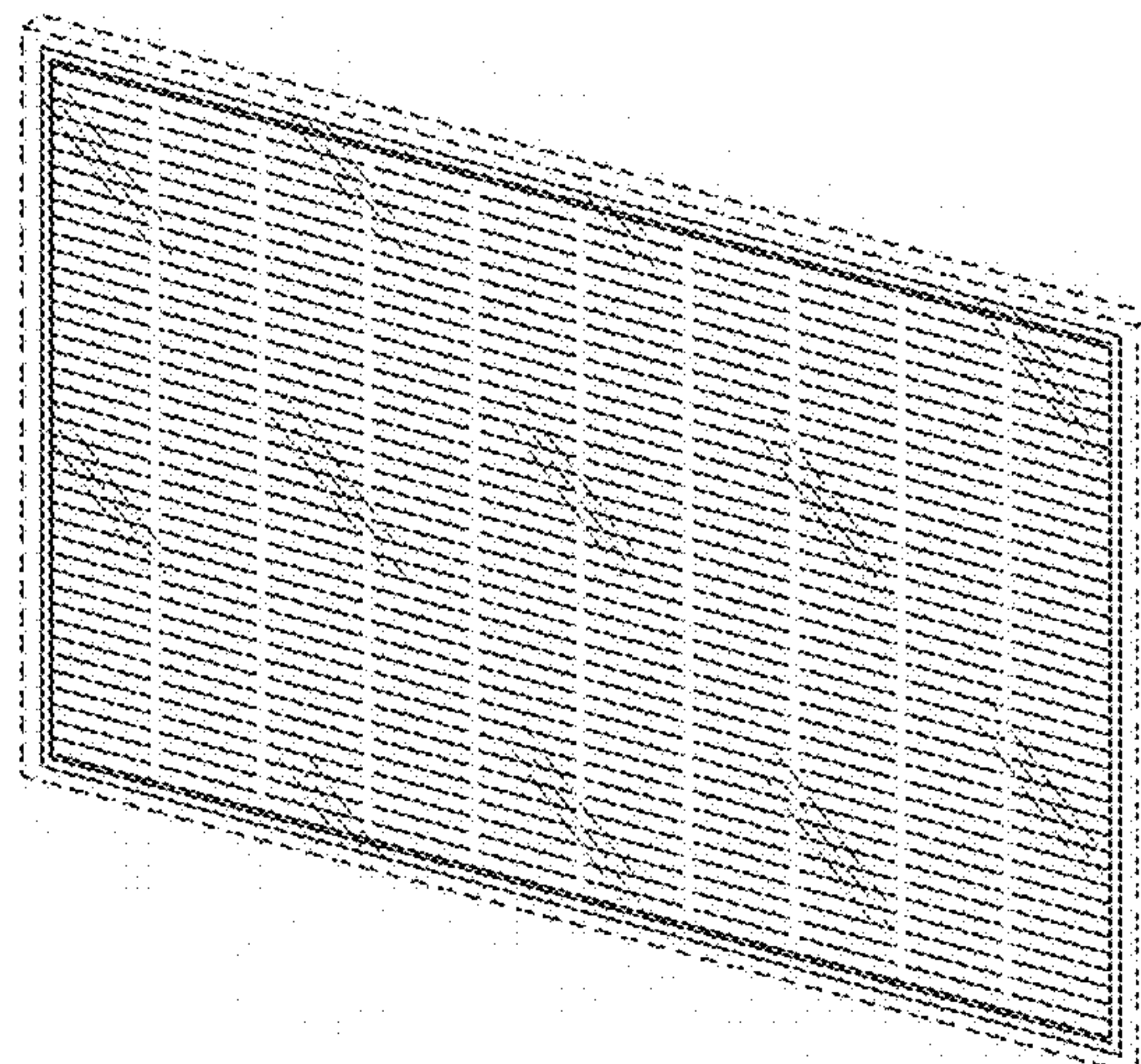
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1 Claim, 6 Drawing Sheets



Related U.S. Application Data

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(58) Field of Classification Search

CPC Y02E 10/40; Y02E 10/44; Y02E 10/50; Y02E 10/52; Y02E 10/542; Y02E 10/544; E04H 4/08; F24J 2/38; F24J 2/0472; F24J 2/542; H01L 31/00; H01L 31/042; H01L 31/045; H01L 31/048; H01L 31/049; H01L 31/052; H01L 31/184; H01L 31/0232; H01L 31/0508; H01L 31/0512; H01L 31/0543; H01L 31/02013; H01L 31/1876; H01L 51/0061; H02S 40/34
See application file for complete search history.

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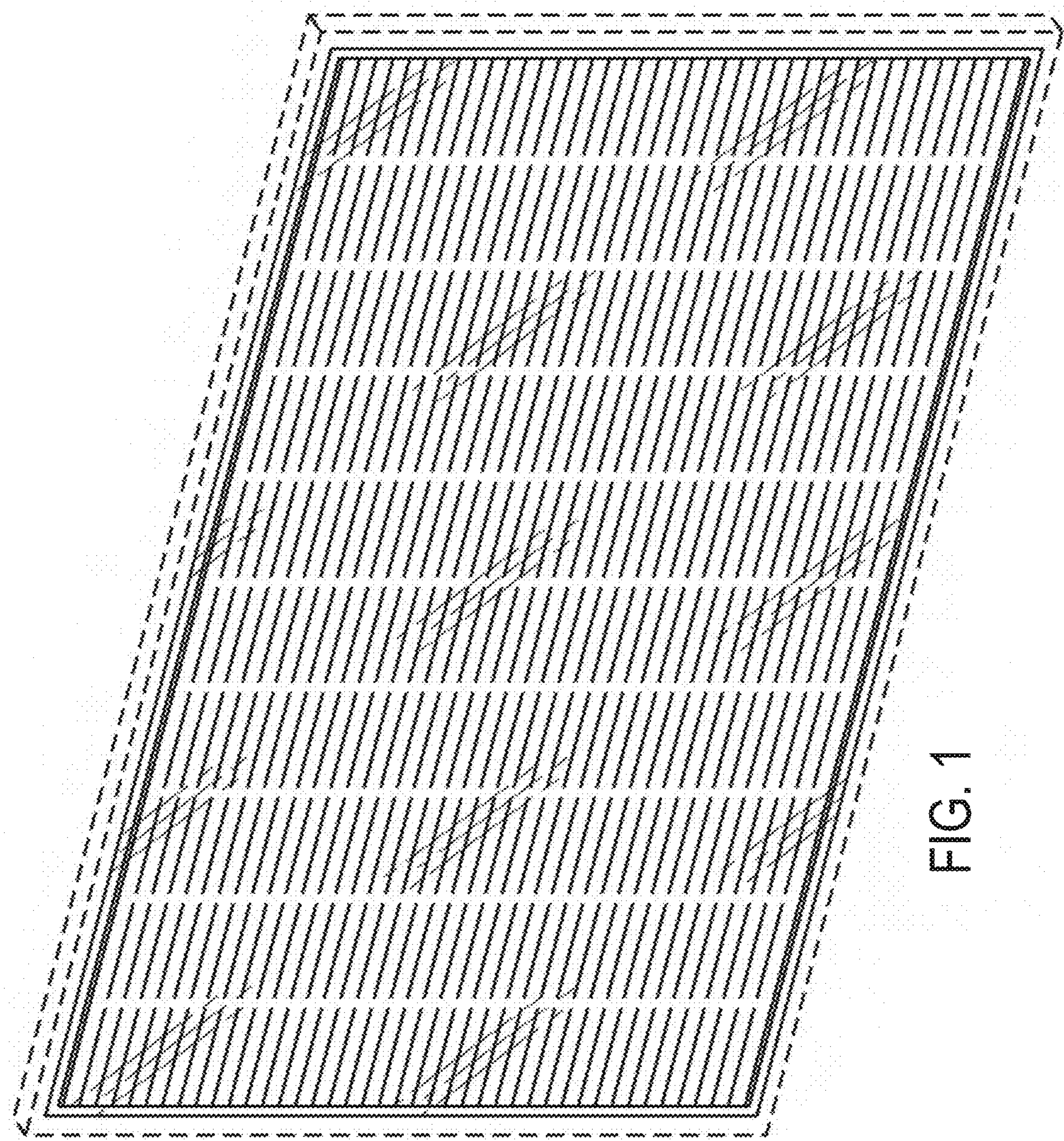


FIG. 1

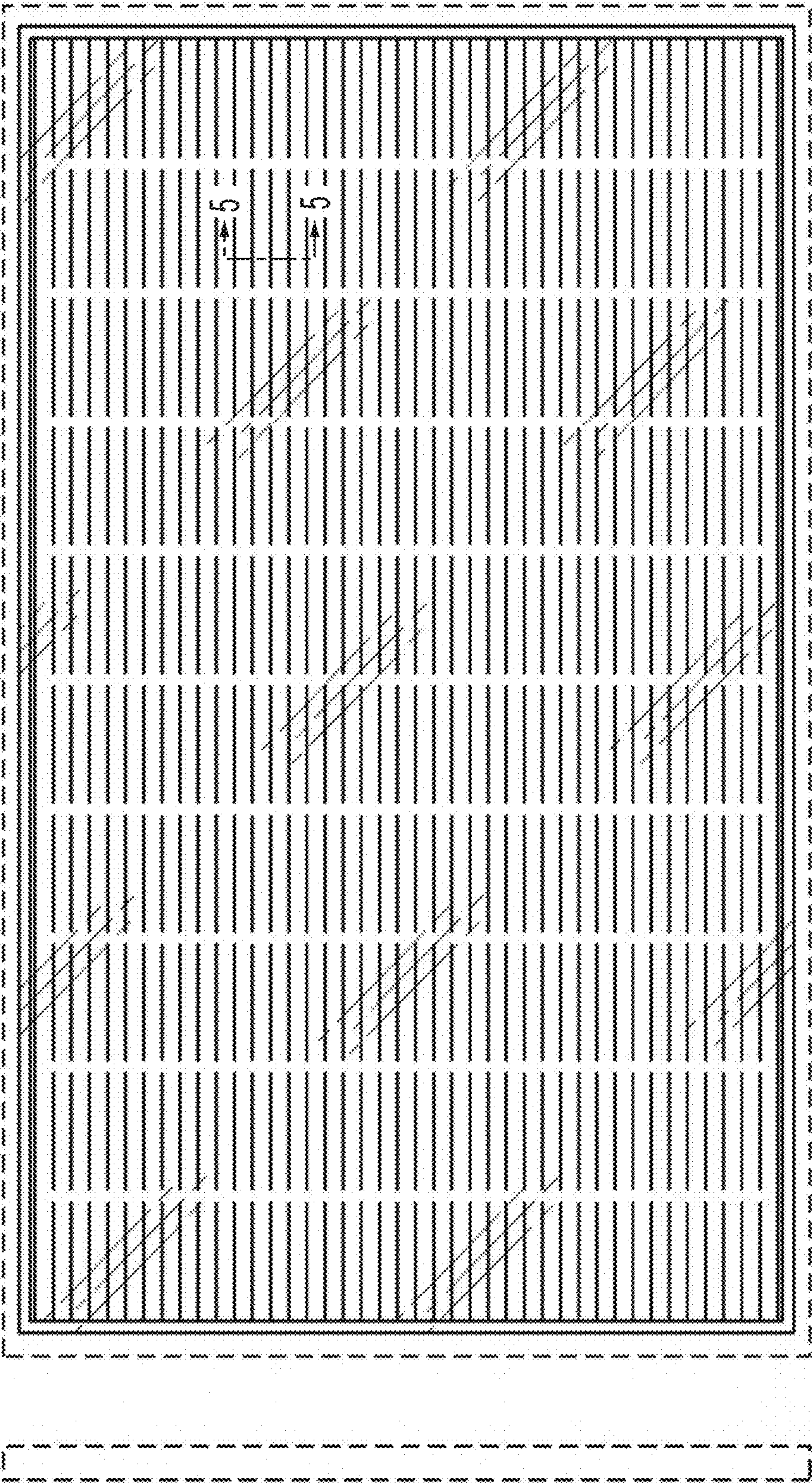


FIG. 2



FIG. 3

FIG. 4



FIG. 5

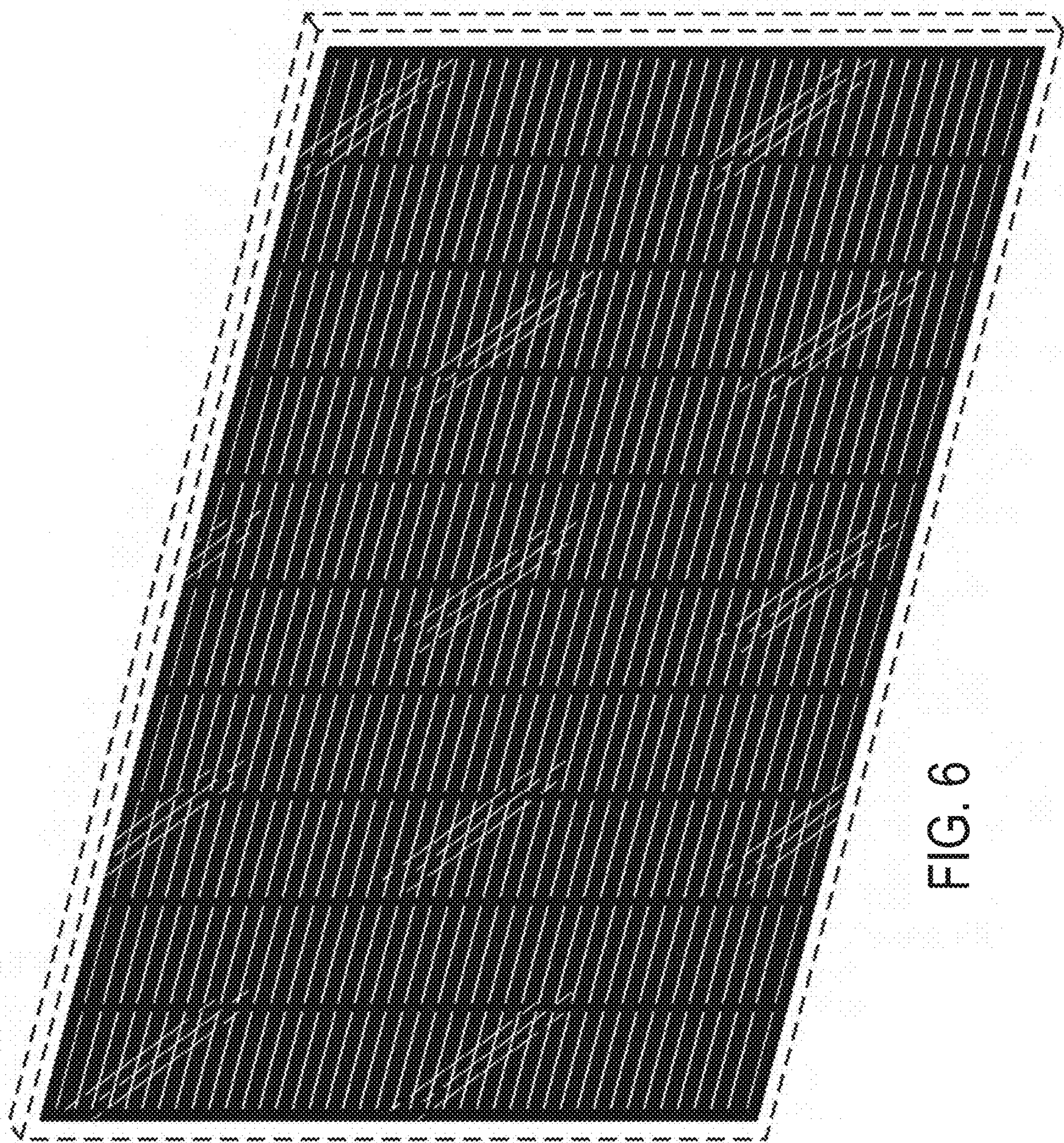


FIG. 6

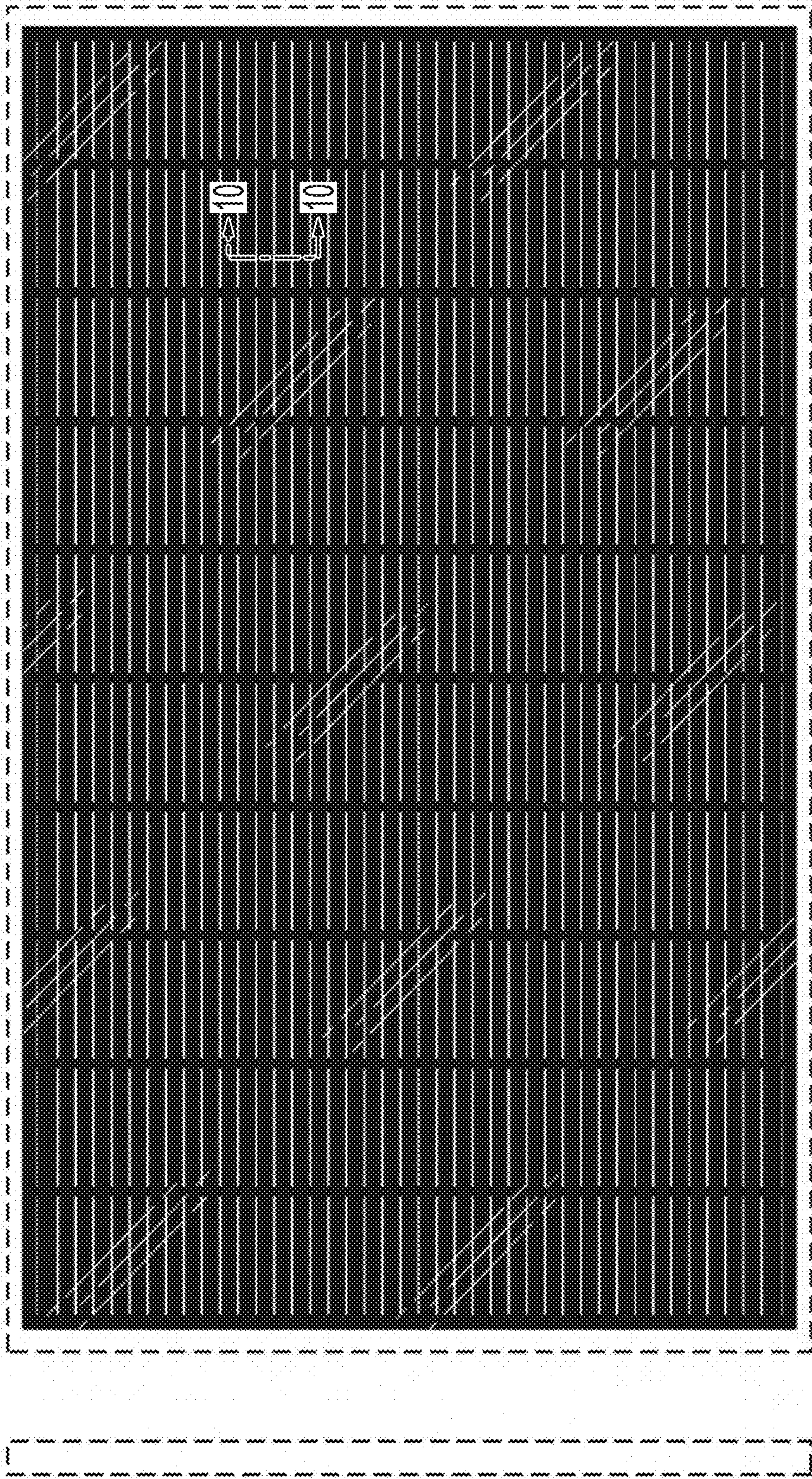


FIG. 7

FIG. 9



FIG. 8



FIG. 10